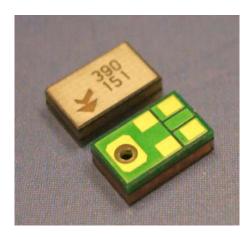




#### "Zero Height" SiSonic<sup>TM</sup> Microphone Specification



# Knowles Acoustics 1151 Maplewood Drive Itasca, IL 60143



Knowles Acoustics, a division of Knowles Electronics, LLC.

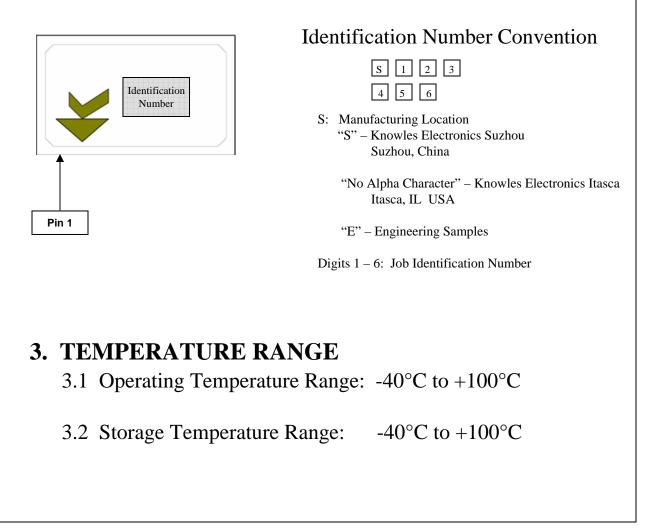




#### **1. DESCRIPTION AND APPLICATION**

- 1.1 Description Zero Height Surface Mount Silicon Microphone
- 1.2 Application Hand held telecommunication devices

#### 2. PART MARKING



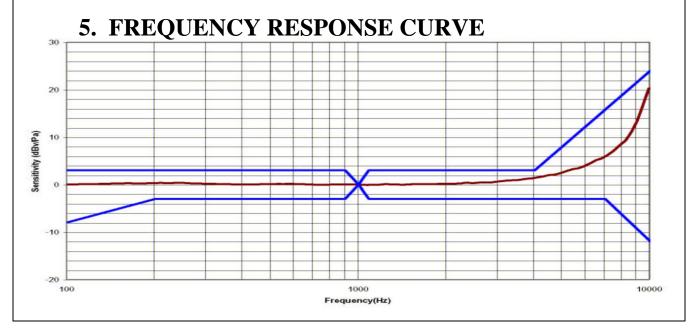




### 4. ACOUSTIC & ELECTRICAL SPECIFICATIONS

Test Conditions: +20°C, 60-70% R.H.

	Symbol	Condition	Limits			Unit
	Symbol		Min.	Nom.	Max.	onit
Directivity		Omni-directional				
Sensitivity	S	@ 1kHz (0dB=1V/Pa)	-46	-42	-38	dB
Output impedance	Z <sub>OUT</sub>	@ 1kHz (0dB=1V/Pa)	n/a	n/a	100	Ω
Current Consumption	I <sub>DSS</sub>	across 1.5 to 5.5 volts	0.100	n/a	0.250	mA
Signal to Noise Ratio	S/N	@ 1kHz (0dB=1V/Pa)	55	59	n/a	dB
Supply Voltage	Vs		1.5	n/a	5.5	V
Typical Input Referred Noise	ENL	A-weighted	n/a	35	n/a	dBA SPL
Sensitivity Loss across Voltage		Change in sensitivity over 5.5v to 1.5v	No Change Across Voltage Range dB			
Maximum Input Sound Level			dB , THD = < 10%			
Contact Resistance					100	Ohms

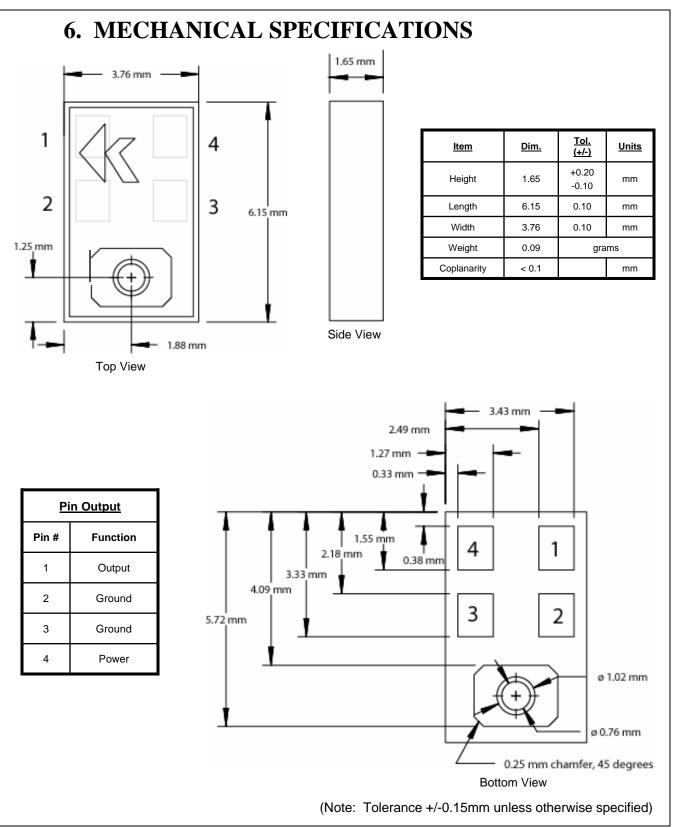




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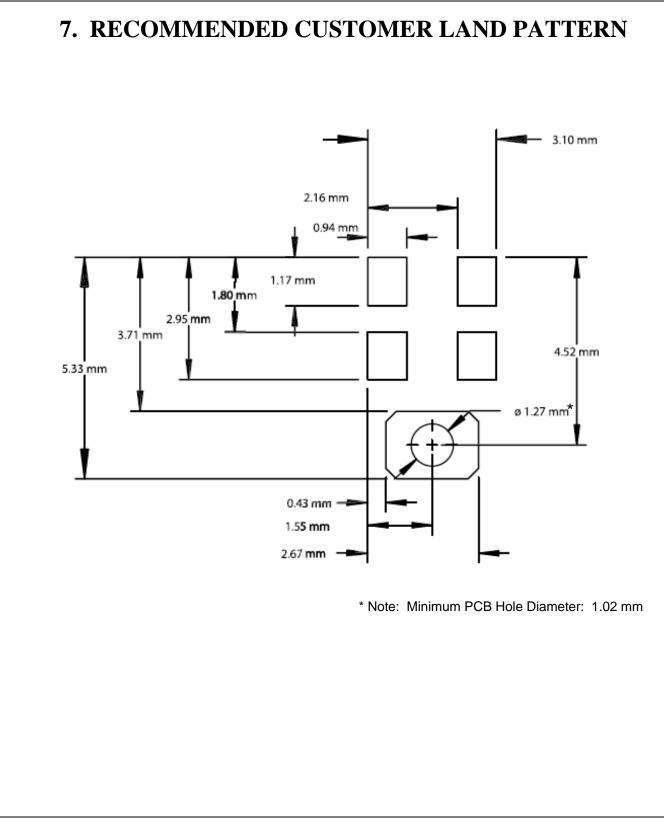






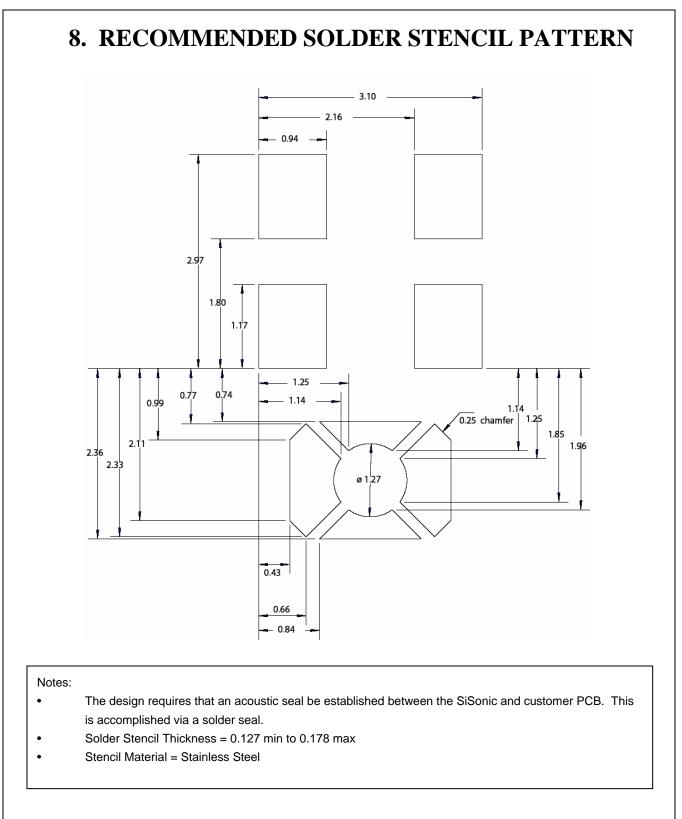
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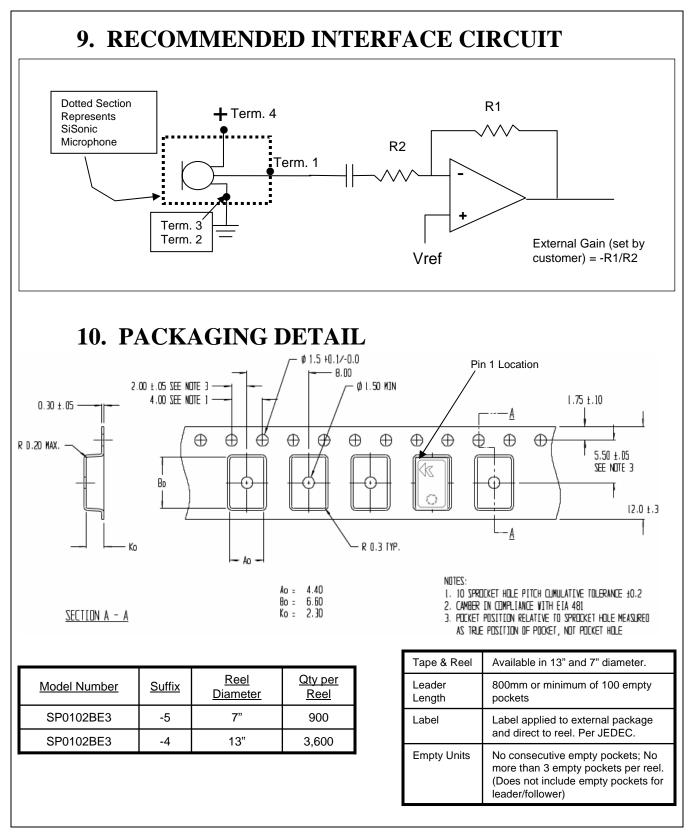




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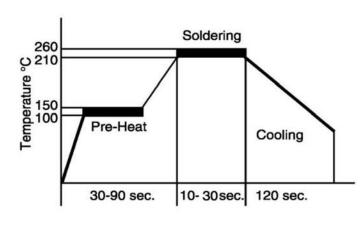








# **11. SOLDER REFLOW PROFILE**



Notes: 1. Maximum condition = 260 C for 30seconds. 2. Do not pull a vacuum over the port hole of the microphone. Pulling a vacuum over the port hole can damage the device. 3. Do not board wash after the reflow process. Board washing and cleaning agents can damage the device. Do not expose to ultrasonic processing or cleaning. 4. Number of Reflow = recommend no more than 2 cycles.

## **12. ADDITIONAL NOTES**

- (A) Packaging (reference SiSonic\_Packaging\_Spec.pdf)
- (B) Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened moisture sensitivity bag under environmental conditions of 30°C, 60% R.H.
- (C) Exposure: Devices should not be exposed to high humidity, high temperature environment. Customer should follow standard baking times as stated in JEDEC J-STD-033A, reference Class 2A.

Out of bag: 90 days out of ESD moisture sensitive bag, assuming 30C/60% RH as maximum.

Baking Condition: After 90 days, recommend baking at 90°C (<5% RH) for 48 hours. (for optional times and temperatures, refer to JEDEC J-STD-033A.







## **13. RELIABILITY SPECIFICATIONS**

Note: After test conditions are performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

Test	Description
Thermal Shock	Microphone unit must operate when exposed to air-to-air thermal shock 100 cycles, from -40°C to +125°C. (IEC 68-2-4),
High Temperature Storage Test	Microphone unit must maintain sensitivity after storage at +105°C for 1,000 hours. (IEC 68-2-2 Test Ba)
Low Temperature Storage Test	Microphone unit must maintain sensitivity after storage at -40°C for 1,000 hours. (IEC 68-2-1 Test Aa)
High Temperature Operating Test	Microphone unit must operate within sensitivity specifications for 1,000 hours at 105°C. (IEC 68-2-2 Test Ba)
Low Temperature Operating Test	Microphone unit must operate within sensitivity specifications for 1,000 hours at -40°C. (IEC 68-2-1 Test Aa)
Humidity Test	Tested under Bias at 85°C/85% R.H. for 1,000 hours. (JESD22-A101A-B)
Vibration Test	Microphone unit must operate under test condition: 4 cycles, from 20 to 2,000 Hz in each direction (x,y,z), 48 minutes, using peak acceleration of 20 G (+20%, -0%). (MIL 883E, method 2007.2, A)
Electrostatic Discharge	Tested to 8kV direct contact discharge or 15kV air discharge as specified by IEC 1000- 4-2, level 3 and level 4.
Reflow	Microphone is tested to 5 passes through reflow oven, with microphone mounted upside-down under conditions of 260°C for 30 seconds maximum.
Mechanical Shock	Microphone must operate after exposure to shock test of 10,000 G per IEC 68-2-27, Ea.







#### **14. SPECIFICATION REVISIONS**

Revision	Detailed Specification Changes	Date	
A	Initial Release	12-1-04	

